

# **PRODUCT SPECIFICATION**

13.3" TFT LCD MODULE
MODEL: T133192108-A0WMN-002 Ver:1.1

< >> Preliminary Specification

< >> Finally Specification

	CUSTOMER'S APPROVAL						
CUSTOMER:							
SIG	NATURE:	DATE:					

APPROVED	PM	PD	PREPARED
BY	REVIEWED	REVIEWED	BY

# **Revision History**

Revision	Date	Originator	Detail	Remarks
Ver 1.0	2018.01.17	ZFY	Initial Release	
1.1	2018.04.11	ZFY	Modify many details	P19/P20

# **Table of Contents**

No.	Ite	em	Page
1.	Gene	ral Description	
2.	Modu	le Parameter	4
3.	Absol	ute Maximum Ratings	4
4.	DC C	haracteristics	5
5.	Backl	ight Characteristic	5
	5.1.	Backlight Characteristic	5
	5.2.	Backlighting circuit	5
6.	Optica	al Characteristics	6
	6.1.	Optical Characteristics	6
	6.2.	Definition of Response Time	6
	6.3.	Definition of Contrast Ratio	7
	6.4.	Definition of Viewing Angles	7
	6.5.	Definition of Color Appearance	8
	6.6.	Definition of Surface Luminance, Uniformity and Transmittance	8
7.	Block	Diagram and Power Supply	9
8.	Interfa	ace Pins Definition	10
9.	AC CI	haracteristics	11
10.	Qualit	ty Assurance	12
	10.1	Purpose	12
	10.2	Standard for Quality Test	12
	10.3	Nonconforming Analysis & Disposition	12
	10.4	Agreement Items	12
	10.5	Standard of the Product Visual Inspection	12
	10.6	Inspection Specification	13
	10.7	Classification of Defects	17
	10.8	Identification/marking criteria	17
	10.9	Packaging	17
11.	Reliat	pility Specification	18
12.	Preca	utions and Warranty	19
	12.1.	Safety	19
	12.2.	Handling	19
	12.3.	Storage	19
	12.4.	Metal Pin (Apply to Products with Metal Pins)	19
	12.5.	Operation	20
	12.6.	Static Electricity	20
	12.7.	Limited Warranty	20
13.	Packa	aging	21
14.	Outlin	e Drawing	22

## 1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

### 2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	13.3"	
Display Mode	Transmissive /Normally black	
Resolution	1920 RGB x 1080	Pixels
View Direction	FULL View	Best Image
Module Outline	305.1(H) x 178(V) x 2.8(T) (Note1)	mm
Active Area	293.76(H) x 165.24(V)	mm
Pixel Pitch	153(H) x 153(V)	um
Pixel Arrangement	RGB Vertical stripe	
Surface treatment	Antiglare	
Display Colors	16M	
Interface	EPD Interface	
With or without the touch panel	Without	
Operating Temperature	0∼50	°C
Storage Temperature	-10~60	°C
Weight	TBD	g

Note 1: Inclusive hooks, posts, FFC/FPC tail etc.

## 3. Absolute Maximum Ratings

V<sub>SS</sub>=0V, Ta=25°C

Item	Symbol	Min.	Max.	Unit
Digital Supply Voltage	VCCS	-0.3	4.0	V
Storage temperature	T <sub>STG</sub>	-10	60	°C
Operating temperature	T <sub>OP</sub>	0	50	°C

**Note 1:** If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

**Note 2:** The response time will be extremely slow when the operating temperature is around -10 $^{\circ}$ C, and the back ground will become darker at high temperature operating.

# 4. DC Characteristics

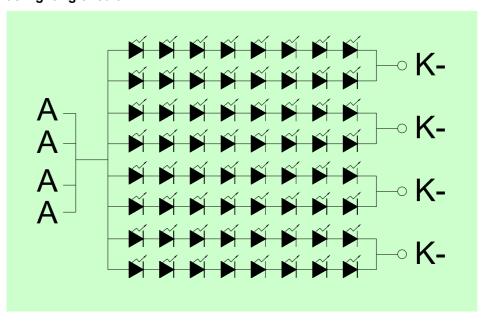
Item		Symbol	Min.	Тур.	Max.	Unit
Supply Voltage		vccs	3	3.3	3.6	V
urrent Consumption All White	Logic Analog	ICC+ IIN	-	TBD	-	mA

# 5. Backlight Characteristic

# 5.1. Backlight Characteristic

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	
Forward Voltage	VF	Ta=25 °C, I <sub>F</sub> =20mA/LED	22.4	25.6	27.2	V	
Forward Current	lF	Ta=25 °C, V <sub>F</sub> =3.2V/LED		160		mA	
Power dissipation	Pb	-		4096		W	
Uniformity	Avg	-	70	-	-	%	
Drive method	Constant current						
LED Configuration	64	White LEDs (8 LEDs in one strin	g and 8 g	groups ir	n paralle	1)	

# 5.2. Backlighting circuit



# 6. Optical Characteristics

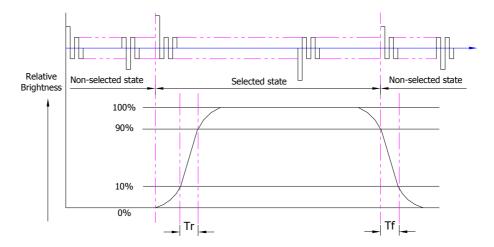
## 6.1. Optical Characteristics

Ta=25°C, VCCS=3.3V, TN LC+ Polarizer

	Item		Cymphol	Condition	S	pecificati	on	Unit
	Item		Symbol	Condition	Min.	Тур.	Max.	Unit
	Luminance on							
<u> </u>	$TFT(I_f = 20)$	mA/LED)	Lv		170	220	-	cd/m²
ode	Contrast rati	o(See 6.3)	CR		600	800	-	
Backlight On (Transmissive Mode)	Response time (See 6.2)		TR+TF		-	25	35	ms
nis		Red	XR			TBD		
nsr		Chromaticity Green	YR			TBD		
Tra	Chromoticity		XG			TBD		
) u	Transmissive		YG			TBD		
) t	(See 6.5)	Blue	Хв			TBD		
igi	(366 0.3)	blue	YB			TBD		
ack ack		White	Xw			TBD		
m	Viewing	VVIIILE	Yw			TBD		
		Horizontal	θx+		-	89	_	
		i iuiizuiilai	θх-	Center CR≥10	-	89	-	Deg.
	Angle (See 6.4)	Vertical	φY+	Center CIVE 10	-	89	-	Deg.
	(000 0.4)	vertical	φY-		-	89	_	

## 6.2. Definition of Response Time

## 6.2.1. Normally Black Type (Negative)

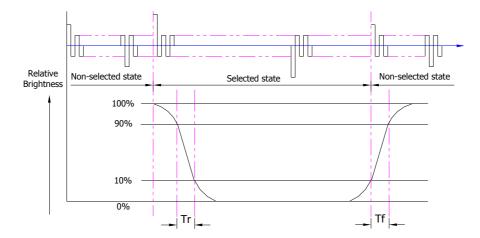


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

## 6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

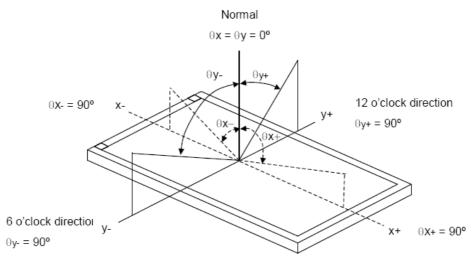
### 6.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	Eldim or Equivalent		
Measuring Point Diameter	3mm//1mm		
Measuring Point Location	Active Area centre point		
Toot pottorn	A: All Pixels white		
Test pattern	B: All Pixel black		
Contrast setting	Maximum		

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

### 6.4. Definition of Viewing Angles

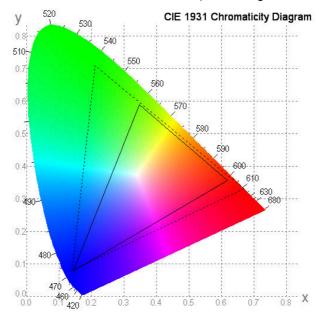


Measuring machine: LCD-5100 or EQUI

# 6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

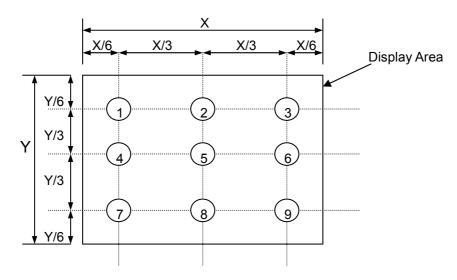


### 6.6. Definition of Surface Luminance, Uniformity and Transmittance

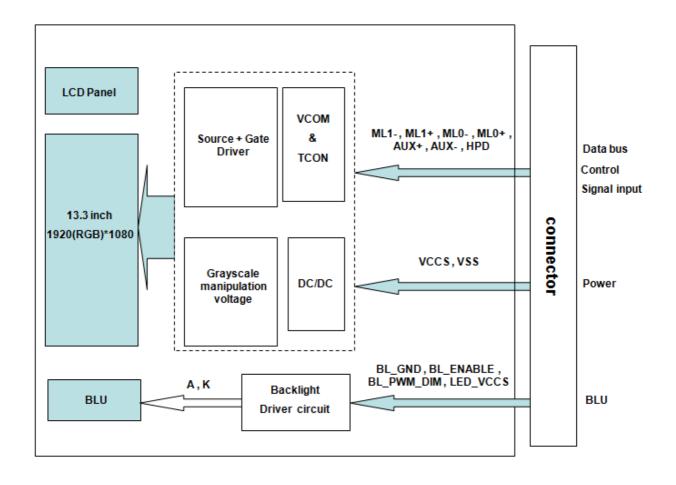
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.6.1. Surface Luminance:  $L_V$  = average ( $L_{P1}$ : $L_{P9}$ )
- 6.6.2. Uniformity = Minimal  $(L_{P1}:L_{P9})$  / Maximal  $(L_{P1}:L_{P9})$  \* 100%
- 6.6.3. Transmittance =  $L_V$  on LCD /  $L_V$  on Backlight \* 100%

Note: Measuring machine: BM-7



# 7. Block Diagram and Power Supply



# 8. Interface Pins Definition

No.	Symbol	Function	Remark
1	NC	No connection	
2	H_GND	High Speed Ground	
3	ML1-	Complement signal-lane 1	
4	ML1+	True signal-Main Lane1	
5	H_GND	High Speed Ground	
6	ML0-	Complement signal-lane 0	
7	ML0+	True signal-Main Lane0	
8	H_GND	High Speed Ground	
9	AUX+	True signal-Auxiliary channel	
10	AUX-	Complement signal-Auxiliary channel	
11	H_GND	High Speed Ground	
12	VCCS	Power supply +3.3V(typical)	
13	VCCS	Power supply +3.3V(typical)	
14	NC	No connection	
15	VSS	Ground	
16	VSS	Ground	
17	HPD	Hot plug detect	
18	BL_GND	Backlight driver circuit ground	
19	BL_GND	Backlight driver circuit ground	
20	BL_GND	Backlight driver circuit ground	
21	BL_GND	Backlight driver circuit ground	
22	BL_ENABLE		
23	BL_PWM_DIM		
24	NC	No connection	
25	NC	No connection	
26	LED_VCCS	Backlight driver circuit power supply	
27	LED_VCCS	Backlight driver circuit power supply	
28	LED_VCCS	Backlight driver circuit power supply	
29	LED_VCCS	Backlight driver circuit power supply	
30	NC	No connection	

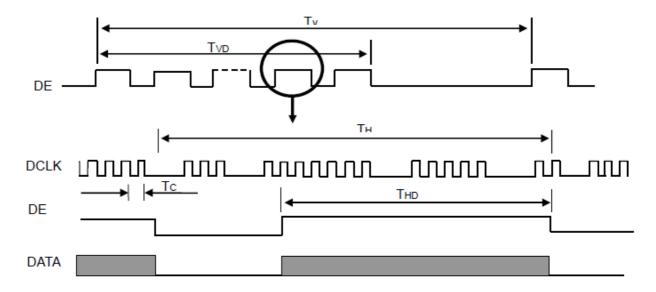
Note: The I2C device addresses are defined as follows. The D-VCOM part is iML7978CL.

Component		Device Address						
	B7	B6	B5	B4	В3	B2	B1	WR
D-VCOM	1	0	0	1	1	1	1	Х

# 9. AC Characteristics

Item	Symbol		Values		Unit	Remark
item	Symbol	Min.	Тур.	Max.	Onit	Kemark
Clock Frequency	fclk	116.17	138.78	142.77	MHz	Frame rate =60Hz
Horizontal display area	thd		1920		DCLK	
HS period time	th	2058	2080	2910	DCLK	
HS Blanking	thb		160		DCLK	
∨ertical display area	tvd		1080		Н	
VS period time	tv	1103	1112	1462	Н	
VS Blanking	thb		32		Н	

# INPUT SIGNAL TIMING DIAGRAM



## 10. Quality Assurance

#### 10.1 Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

## 10.2 Standard for Quality Test

10.2.1 Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

10.2.2 Sampling Criteria:

Visual inspection: AQL 1.5% Electrical functional: AQL 0.65%.

10.2.3 Reliability Test:

Detailed requirement refer to Reliability Test Specification.

#### 10.3 Nonconforming Analysis & Disposition

- 10.3.1 Nonconforming analysis:
  - 10.3.1.1 Customer should provide overall information of non-conforming sample for their complaints.
  - 10.3.1.2 After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.
  - 10.3.1.3 If cannot finish the analysis on time, customer will be notified with the progress status.
- 10.3.2 Disposition of nonconforming:
  - 10.3.2.1 Non-conforming product over PPM level will be replaced.
  - 10.3.2.2 The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

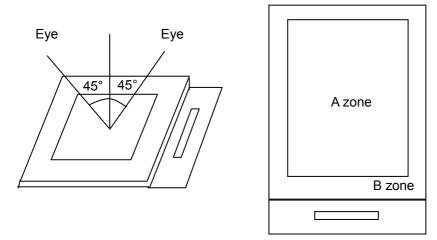
#### 10.4 Agreement Items

Shall negotiate with customer if the following situation occurs:

- 10.4.1 There is any discrepancy in standard of quality assurance.
- 10.4.2 Additional requirement to be added in product specification.
- 10.4.3 Any other special problem.

#### 10.5 Standard of the Product Visual Inspection

- 10.5.1 Appearance inspection:
  - 10.5.1.1 The inspection must be under illumination about 1000 1500 lx, and the distance of view must be at 30cm ± 2cm.
  - 10.5.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.
  - 10.5.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area,

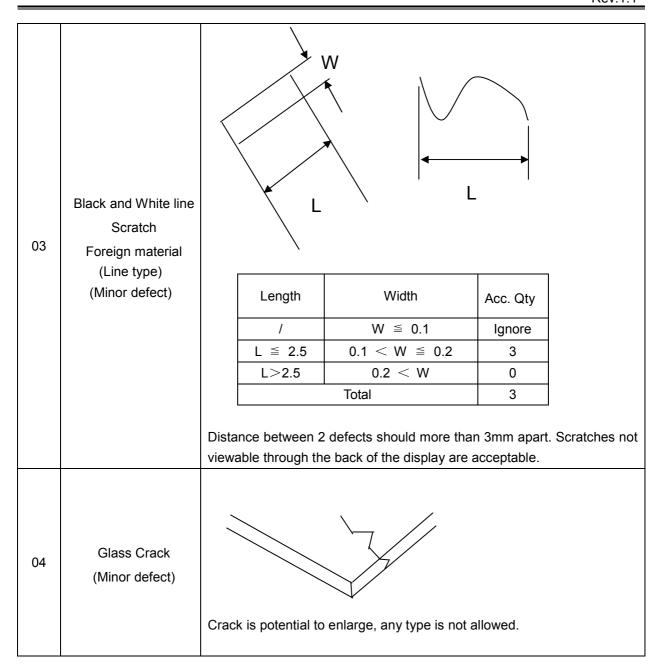


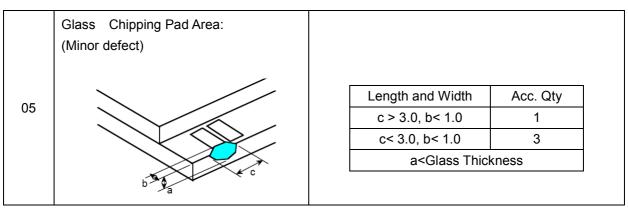
# 10.5.2 Basic principle:

- 10.5.2.1 A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.
- 10.5.2.2 New item must be added on time when it is necessary.

## 10.6 Inspection Specification

No.	Item	Criteria (Unit: mm)			
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	b φ= (a + b)/2 Distance between 2 defects sl	Size φ≤0.20 0.20<φ≤0 0.50<φ	.50 I	cc. Qty gnore N≤3 0
02	Electrical Defect (Minor defect)	Bright dot  Dark dot  Total dot	N ≤ 2 N ≤ 4 N ≤ 4 N ≤ 4 Not visible thro	Total N ≤ 2 N ≤ 4 N ≤ 4 Dugh 5% ND s.	Note 1 Note 2





	Glass Chipping Rear of Pad Area: (Minor defect)					
06	,	Length and Width	Acc. Qty			
		c > 3.0, b< 1.0	1			
		c< 3.0, b< 1.0	2			
		c< 3.0, b< 0.5	4			
		a <glass td="" thickness<=""></glass>				
	b a					
	Glass Chipping Except Pad Area: (Minor defect)					
		Length and Width	Acc. Qty			
		c > 3.0, b< 1.0	1			
07		c< 3.0, b< 1.0	2			
		c< 3.0, b< 0.5	4			
		a <glass td="" thic<=""><td>kness</td></glass>	kness			
	a					
	Glass Corner Chipping: (Minor defect)					
		Length and Width	Acc. Qty			
		c < 3.0, b< 3.0	Ignore			
08		a <glass td="" thickness<=""></glass>				
	ba					
	Glass Burr:					
	(Minor defect)					
		Length	Acc. Qty			
09	F	F < 1.0	Ignore			
		1 - 1.0	19.1010			
	F	Glass burr don't affect as dimension.	semble and module			

10	FPC Defect: (Minor defect)		<ul><li>10.1 Dent, pinhole width a<w 3.<="" li=""><li>(w: circuitry width.)</li><li>10.2 Open circuit is unacceptable.</li><li>10.3 No oxidation, contamination and distortion.</li></w></li></ul>		
11	Bubble on Polarizer (Minor defect)		Diameter $\phi \le 0.30$ $0.30 < \phi \le 0.50$ $0.50 < \phi$	Acc. Qty Ignore N≤2 N=0	
12	Dent on Polarizer (Minor defect)		Diameter $\phi \le 0.25$ $0.25 < \phi \le 0.50$ $0.50 < \phi$	Acc. Qty Ignore N≤4 None	
13	Bezel	<ul><li>13.1 No rust, distortion on the Bezel.</li><li>13.2 No visible fingerprints, stains or other contamination.</li></ul>			
14	Touch Panel	D: Diameter W: width L: length  14.1 Spot: D<0.25 is acceptable  0.25 ≤ D ≤ 0.4  2dots are acceptable and the distance between defects should more than  10 mm.  D>0.4 is unacceptable  14.2 Dent: D>0.40 is unacceptable  14.3 Scratch: W ≤ 0.03, L ≤ 10 is acceptable,  0.03 <w 0.10,="" 10="" 2="" acceptable="" between="" defects="" distance="" is="" l="" mm.="" more="" should="" than="" w="" ≤="">0.10 is unacceptable.</w>			
15	РСВ	15.1 No distortion or contamination on PCB terminals. 15.2 All components on PCB must same as documented on the BOM/component layout. 15.3 Follow IPC-A-600F.			
16	Soldering	Follow IPC-A-610C standard			

17	Electrical Defect (Major defect)	The below defects must be rejected.  17.1 Missing vertical / horizontal segment,  17.2 Abnormal Display.  17.3 No function or no display.  17.4 Current exceeds product specifications.  17.5 LCD viewing angle defect.  17.6 No Backlight.  17.7 Dark Backlight.  17.8 Touch Panel no function.
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Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

#### 10.7 Classification of Defects

- 10.7.1 Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 10.7.2 Two minor defects are equal to one major in lot sampling inspection.

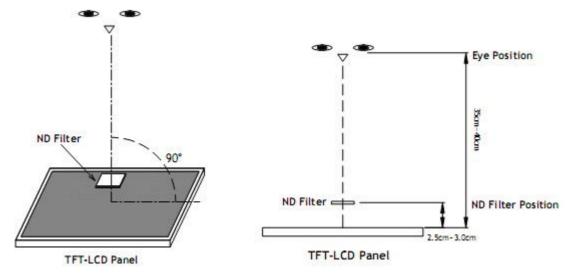
#### 10.8 Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

### 10.9 Packaging

- 10.9.1 There should be no damage of the outside carton box, each packaging box should have one identical label.
- 10.9.2 Modules inside package box should have compliant mark.
- 10.9.3 All direct package materials shall offer ESD protection

**Note1**: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is  $350 \text{mm} \pm 50 \text{mm}$ .

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is  $350 \text{mm} \pm 50 \text{mm}$ .

**Note2:** Mura on display which appears darker / brighter against background brightness on parts of display area.

# 11. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	50℃, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	0℃, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity	40℃, 80%RH, 96Hrs	2	GB/T2423.3 -2006
4	High Temperature Storage	60℃, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-10℃, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test	0°C, 60min~50°C, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X,Y,Z 30 min for each direction.	2	GB/T5170.14 -2009
8	Electrical Static Discharge	Air: $\pm$ 8KV 150pF/330 $\Omega$ 5 times	2	GB/T17626.2 -2006
		Contact: $\pm$ 4KV 150pF/330 $\Omega$ 5 times		
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

# 12. Precautions and Warranty

#### 12.1. Safety

12.1.1 The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

12.1.2 Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

#### 12.2. Handling

12.2.1 Reverse and use within ratings in order to keep performance and prevent damage.

12.2.2 Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

#### 12.3.Storage

12.3.1. Do not store the LCD module beyond the specified temperature ranges.

12.3.2. Strong light exposure causes degradation of polarizer and color filter

## 12.4. Metal Pin (Apply to Products with Metal Pins)

12.4.1 Pins of LCD and Backlight

12.4.1.1 Solder tip can touch and press on the tip of Pin LEAD during the soldering

12.4.1.2 Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

Maximum Solder Temperature: 370 ℃

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20 ℃

Typical Soldering Time: ≤3s

12.4.1.3 Solder Wetting

Solder Pin Lead
Recommended

Solder Pin Lead
Not Recommended

#### 12.4.2Pins of EL

12.4.2.1 Solder tip can touch and press on the tip of EL leads during soldering.

12.4.2.2 No Solder Paste on the soldering pad on the motherboard is recommended.

12.4.2.3 Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290 ℃

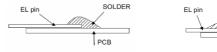
Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

12.4.2.4 No horizontal press on the EL leads during soldering.

12.4.2.5 180° bend EL leads three times is not allowed.

#### 12.4.2.6 Solder Wetting



Recommended

Not Recommended

12.4.2.7 The type of the solder iron:





Recommended

Not Recommended

12.4.2.8 Solder Pad



#### 12.5. Operation

- 12.5.1. Do not drive LCD with DC voltage
- 12.5.2. Response time will increase below lower temperature
- 12.5.3. Display may change color with different temperature
- 12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".
- 12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 12.5.8. Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it may develop image sticking due to the TFT structure.

#### 12.6. Static Electricity

- 12.5.1 CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.5.2 The normal static prevention measures should be observed for work clothes and benches.
- 12.5.3 The module should be kept into anti-static bags or other containers resistant to static for storage.

#### 12.7. Limited Warranty

- 12.7.1 Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2 If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 12.7.3 After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

# 13. Packaging

TBD

